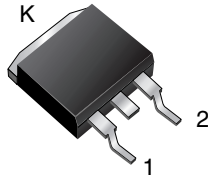


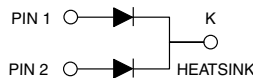
## Dual Common Cathode Schottky Rectifier

High Barrier Technology for Improved High Temperature Performance

### D<sup>2</sup>PAK (TO-263AB)



### MBRB25HxxCT



### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 15 A
$V_{RRM}$	35 V, 45 V, 60 V
$I_{FSM}$	150 A
$V_F$	0.54 V, 0.60 V
$I_R$	100 $\mu$ A
$T_J$ max.	175 °C
Package	D <sup>2</sup> PAK (TO-263AB)
Circuit configuration	Common cathode

### FEATURES

- Power pack
- Guardring for overvoltage protection
- Lower power losses, high efficiency
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### TYPICAL APPLICATIONS

For use in low voltage, high frequency rectifier of switching mode power supplies, freewheeling diodes, DC/DC converters, or polarity protection application.

### MECHANICAL DATA

**Case:** D<sup>2</sup>PAK (TO-263AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/NHM3 - RoHS-compliant, halogen-free, AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** as marked

MAXIMUM RATINGS ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	MBRB25H35CT	MBRB25H45CT	MBRB25H60CT	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	35	45	60	V
Working peak reverse voltage	$V_{RWM}$	35	45	60	
Maximum DC blocking voltage	$V_{DC}$	35	45	60	
Max. average forward rectified current (fig. 1) <small>total device per diode</small>	$I_{F(AV)}$	30			A
		15			
Non-repetitive avalanche energy per diode at 25 °C, $I_{AS} = 4\text{ A}$ , $L = 10\text{ mH}$	$E_{AS}$	80			mJ
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	$I_{FSM}$	150			A
Peak repetitive reverse surge current per diode at $t_p = 2.0\text{ }\mu\text{s}$ , 1 kHz	$I_{RRM}$	1.0	1.0	0.5	A
Peak non-repetitive reverse energy (8/20 $\mu\text{s}$ waveform)	$E_{RSM}$	25	25	20	mJ
Electrostatic discharge capacitor voltage Human body model: $C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$	$V_C$	25			kV
Voltage rate of change (rated $V_R$ )	$dV/dt$	10 000			V/ $\mu\text{s}$
Operating junction and storage temperature range	$T_J, T_{STG}$	-65 to +175			°C



ELECTRICAL CHARACTERISTICS (T <sub>C</sub> = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MBRB25H35CT MBRB25H45CT		MBRB25H60CT		UNIT
				TYP.	MAX.	TYP.	MAX.	
Maximum instantaneous forward voltage per diode	V <sub>F</sub> <sup>(1)</sup>	I <sub>F</sub> = 15 A	T <sub>J</sub> = 25 °C	-	0.64	-	0.70	V
			T <sub>J</sub> = 125 °C	0.50	0.54	0.56	0.60	
		I <sub>F</sub> = 30 A	T <sub>J</sub> = 25 °C	-	0.74	-	0.85	
			T <sub>J</sub> = 125 °C	0.63	0.67	0.68	0.72	
Maximum reverse current per diode	I <sub>R</sub> <sup>(2)</sup>	Rated V <sub>R</sub>	T <sub>J</sub> = 25 °C	-	100	-	100	μA
			T <sub>J</sub> = 125 °C	6.0	20	4.0	20	mA

**Notes**

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>C</sub> = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	MBRB	UNIT
Thermal resistance, junction to case per diode	R <sub>θJC</sub>	1.5	°C/W

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
D <sup>2</sup> PAK (TO-263AB)	MBRB25H60CTHM3/I	1.35	I	800/reel	Tape and reel



## RATINGS AND CHARACTERISTICS CURVES ( $T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)

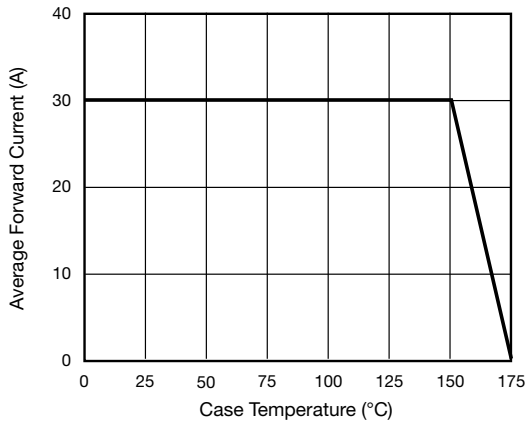


Fig. 1 - Forward Derating Curve (Total)

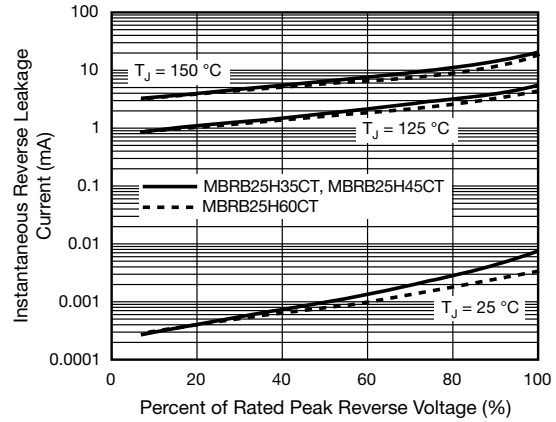


Fig. 4 - Typical Reverse Characteristics Per Diode

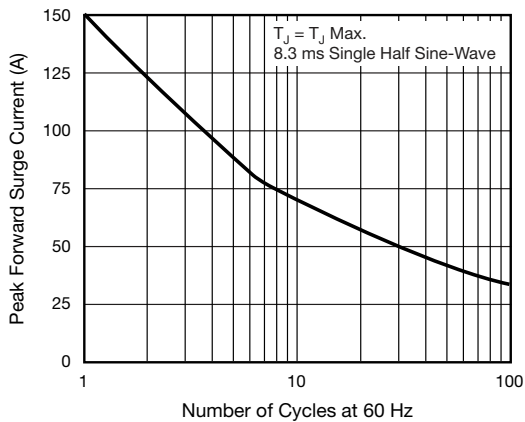


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

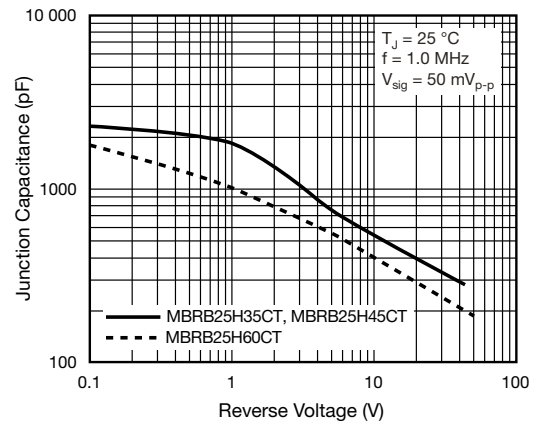


Fig. 5 - Typical Junction Capacitance Per Diode

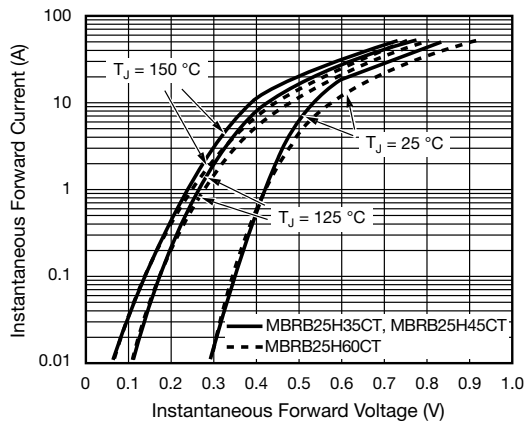


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

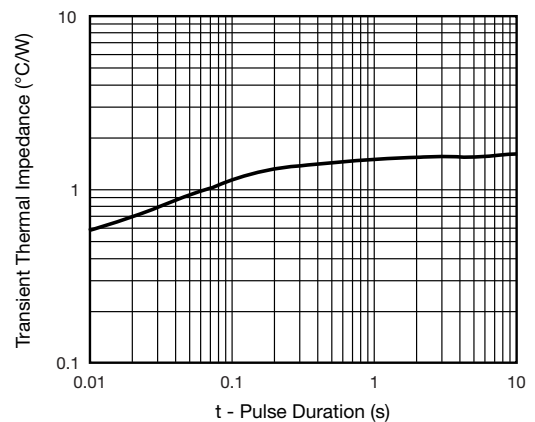
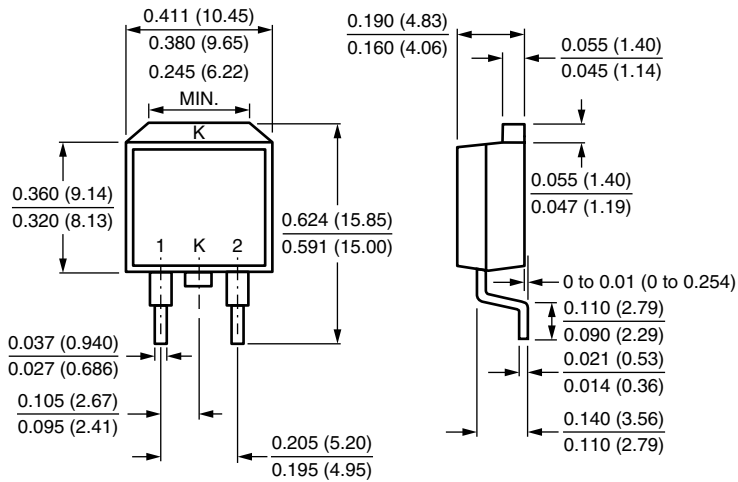


Fig. 6 - Typical Transient Thermal Impedance Per Diode

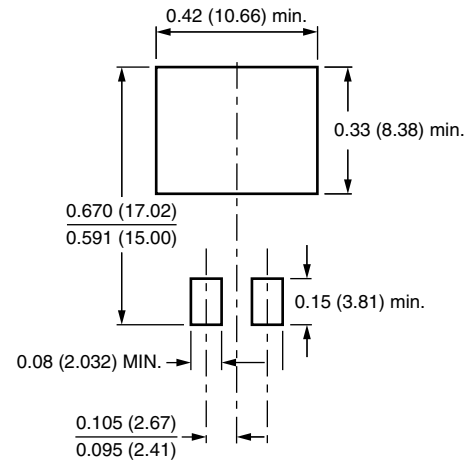


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### D<sup>2</sup>PAK (TO-263AB)



### Mounting Pad Layout





## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.